L Number	Hits	Search Text	DB	Time stamp
1	2	jp-2001057361-\$.did.	USPAT;	2004/04/08 13:13
			US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
2	0	jp-0462170-\$.did.	USPAT;	2004/04/08 13:13
			US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
_	4	:- 04000470 ft did	IBM_TDB	2004/04/08 13:14
3	. 1	jp-04062170-\$.did.	USPAT; US-PGPUB;	2004/04/06 13.14
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
4	0	jp-4062170-\$.did.	USPAT;	2004/04/08 13:14
7	U	jp=4002170=ψ.αια. 	US-PGPUB;	200-70-700 10:14
1			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
5	36	"4397724"	USPAT;	2004/04/08 13:15
"	•	1007721	US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
6	1	("4397724").PN.	USPAT;	2004/04/08 13:15
		` '	US-PGPUB	
10	2533	118/728.ccls. or 156/345.51.ccls.	USPAT;	2004/04/08 13:28
			US-PGPUB,	
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
11	160	(118/728.ccls. or 156/345.51.ccls.) and polymer	USPAT;	2004/04/08 13:50
			US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
12	2373	(118/728.ccls. or 156/345.51.ccls.) not ((118/728.ccls. or	USPAT;	2004/04/08 13:50
		156/345.51.ccls.) and polymer)	US-PGPUB;	
			EPO; JPO;	
		·	DERWENT;	
			IBM_TDB	
13	743	((118/728.ccls. or 156/345.51.ccls.) not ((118/728.ccls. or	USPAT;	2004/04/08 14:20
		156/345.51.ccls.) and polymer)) and ring	US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
44	44770	water adi abaarb\$2	IBM_TDB	2004/04/00 44 20
14	41778	water adj absorb\$3	USPAT;	2004/04/08 14:20
			US-PGPUB;	1
			EPO; JPO;	
			DERWENT;	
15	10151	(water adj absorb\$3) near3 (resin or polymer)	IBM_TDB USPAT;	2004/04/08 14:21
13	10151	(water adj absorb\$3) flear3 (resiit or polyffler)	US-PGPUB;	2004/04/06 14.21
			EPO; JPO;	
			DERWENT;	
			IBM TDB	
16	542388	118/\$.ccls. or 156/\$.ccls. or 204/\$.ccls. or 315/\$.ccls. or	USPAT;	2004/04/08 14:23
10	3-2300	438/\$.ccls. or 427/\$.ccls. or 216/\$.ccls.	US-PGPUB;	2007/07/00 17.20
		10014.0013. 01 42114.0013. 01 21014.0013.	EPO; JPO;	
			DERWENT;	
			IBM TDB	
17	199	(118/\$.ccls. or 156/\$.ccls. or 204/\$.ccls. or 315/\$.ccls. or	USPAT;	2004/04/08 14:26
''	100	438/\$.ccls. or 427/\$.ccls. or 216/\$.ccls.) and ((water adj	US-PGPUB;	2004,04,00 14.20
1		· - · - · · · · · · · · · · · · ·		i .
		absorb\$3) near3 (resin or polymer))	EPO; JPO; DERWENT;	

18	65550	(118/\$.ccls. or 156/\$.ccls. or 204/\$.ccls. or 315/\$.ccls. or 438/\$.ccls. or 427/\$.ccls. or 216/\$.ccls.) and polymer	USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/04/08 14:26
			IBM_TDB	
19	138	((118/\$.ccls. or 156/\$.ccls. or 204/\$.ccls. or 315/\$.ccls. or	USPAT;	2004/04/08 14:41
		438/\$.ccls. or 427/\$.ccls. or 216/\$.ccls.) and polymer) and	US-PGPUB;	
		(plasma adj resist\$3)	EPO; JPO;	
			DERWENT; IBM_TDB	
20	241	(kunihiko near koroyasu).in. or (muneo near furuse).in. or	USPAT;	2004/04/08 14:43
		(tomoyuki near tamura).in.	US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
_	2706	fluorine adj resin	IBM_TDB USPAT;	2002/02/28 15:03
		The state of the s	US-PGPUB	2002/02/20 10:00
-	41615	thermal adj conductivity	USPAT;	2002/02/28 15:03
	0.40		US-PGPUB	
-	210	(thermal adj conductivity) and (fluorine adj resin)	USPAT;	2002/02/28 15:03
_	2	((fluorine adj resin) same (thermal adj conductivity)) and quartz	US-PGPUB USPAT;	2002/02/28 15:24
	_	(massing day room) daine (mornial day conductivity)) and quarte	US-PGPUB	
-	34	(fluorine adj resin) same (thermal adj conductivity)	USPAT;	2002/02/28 15:22
			US-PGPUB	000010010010010
-	6350	(ceramic\$1 or (silicon adj carbide)) same (thermal adj conductivity)	USPAT; US-PGPUB	2002/02/28 16:28
<u>-</u>	871	((ceramic\$1 or (silicon adj carbide)) same (thermal adj	USPAT;	2002/02/28 15:24
		conductivity)) and quartz	US-PGPUB	
- 0	199	((ceramic\$1 or (silicon adj carbide)) same (thermal adj	USPAT;	2002/02/28 17:00
	109	conductivity) same quartz) (((ceramic\$1 or (silicon adj carbide)) same (thermal adj	US-PGPUB USPAT;	2002/02/20 45:26
-	109	conductivity) same quartz)) and ((liner or shield or protect\$3 or	US-PGPUB	2002/02/28 15:36
		cover\$3) same wall or chamber)	001010	
-	65	(((ceramic\$1 or (silicon adj carbide)) same (thermal adj	USPAT;	2002/02/28 15:57
		conductivity) same quartz)) and ((liner or shield or protect\$3 or cover\$3) same wall)	US-PGPUB	
_	25	((ceramic\$1 or (silicon adj carbide)) same (thermal adj	JPO;	2002/02/28 15:55
		conductivity) same quartz)	DERWENT	2002/02/20 10:00
-	0	((((ceramic\$1 or (silicon adj carbide)) same (thermal adj	JPO;	2002/02/28 15:58
		conductivity) same quartz)) and ((liner or shield or protect\$3 or	DERWENT	
'		cover\$3) same wall or chamber)) and ((liner or shield or protect\$3 or cover\$3) same wall)		
-	0	((((ceramic\$1 or (silicon adj carbide)) same (thermal adj	JPO;	2002/02/28 15:58
		conductivity) same quartz)) and ((liner or shield or protect\$3 or	DERWENT	
		cover\$3) same wall or chamber)) and (liner or shield or protect\$3 or cover\$3)		
_	1534742	protect\$3 or cover\$3) liner or shield or protect\$3 or cover\$3	JPO;	2002/02/28 17:01
		•	DERWENT	
	23143	(liner or shield or protect\$3 or cover\$3) same ceramic	JPO;	2002/02/28 16:06
	1042	(liner) same ceramic	DERWENT	2002/02/20 40:02
-	1042	(liner) same ceramic	JPO; DERWENT	2002/02/28 16:23
-	28	((liner) same ceramic) and plasma	JPO;	2002/02/28 16:23
			DERWENT	
-	16	(((liner) same ceramic) and plasma) and @pd<19941215	JPO;	2002/02/28 16:23
<u> </u>	180	(liner) same alumina	DERWENT JPO:	2002/02/28 16:23
			DERWENT	2002/02/20 10.20
-	6	((liner) same alumina) and plasma	JPO;	2002/02/28 16:23
	5	(((liner) came alumina) and planned and 100 to 100	DERWENT	2002/02/02 12:22
-	5	(((liner) same alumina) and plasma) and @pd<19941215	JPO; DERWENT	2002/02/28 16:38
-	186	(ceramic\$1 same quartz) same (thermal adj conductivity)	USPAT;	2002/02/28 16:38
		, , , , , , , , , , , , , , , , , , , ,	US-PGPUB;	
			EPO; JPO;	
			DERWENT; IBM_TDB	
			ם חו _ואוטו	

	15	((ceramic\$1 same quartz) same (thermal adj conductivity)) and	JPO;	2002/02/28 16:43
		@pd<19941215	DERWENT	
-	90	((ceramic\$1 same quartz) same (thermal adj conductivity)) and	USPAT;	2002/02/28 16:43
		@pd<19941215	US-PGPUB;	
		J.	EPO; JPO;	
			DERWENT;	
			IBM_TDB	
	75	(((ceramic\$1 same quartz) same (thermal adj conductivity))	USPAT;	2002/02/28 16:43
		and @pd<19941215) not (((ceramic\$1 same quartz) same	US-PGPUB;	
		(thermal adj conductivity)) and @pd<19941215)	EPO; JPO;	
			DERWENT;	
			IBM_TDB	
	116423	liner	USPAT;	2002/02/28 17:05
			US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
İ			IBM_TDB	
.	4089	liner and plasma	USPAT;	2002/02/28 17:08
			US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
	2100	(liner and plasma) and wall	USPAT;	2002/02/28 17:07
			US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	24911	liner same wall	USPAT;	2002/02/28 17:06
			US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	934	(liner same wall) and plasma	USPAT;	2002/02/28 17:09
			US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
	1		IBM TDB	1